

## Insulated Gate Bipolar Transistor (Trench IGBT), 100 A


**SOT-227**

| PRODUCT SUMMARY                      |                 |
|--------------------------------------|-----------------|
| $V_{CES}$                            | 1200 V          |
| $I_C$ DC                             | 100 A at 119 °C |
| $V_{CE(on)}$ typical at 100 A, 25 °C | 1.73 V          |

**FEATURES**

- Trench IGBT technology with positive temperature coefficient
- Square RBSOA
- 10  $\mu$ s short circuit capability
- HEXFRED® antiparallel diodes with ultrasoft reverse recovery
- $T_J$  maximum = 150 °C
- Fully isolated package
- Very low internal inductance ( $\leq 5$  nH typical)
- Industry standard outline
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC


**RoHS  
COMPLIANT**
**BENEFITS**

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Speed 4 kHz to 30 kHz
- Very low  $V_{CE(on)}$
- Low EMI, requires less snubbing

| ABSOLUTE MAXIMUM RATINGS         |                      |                                   |          |       |
|----------------------------------|----------------------|-----------------------------------|----------|-------|
| PARAMETER                        | SYMBOL               | TEST CONDITIONS                   | MAX.     | UNITS |
| Collector to emitter voltage     | $V_{CES}$            |                                   | 1200     | V     |
| Continuous collector current     | $I_C$ <sup>(1)</sup> | $T_C = 25\text{ °C}$              | 258      | A     |
|                                  |                      | $T_C = 80\text{ °C}$              | 174      |       |
| Pulsed collector current         | $I_{CM}$             |                                   | 450      |       |
| Clamped inductive load current   | $I_{LM}$             |                                   | 450      |       |
| Diode continuous forward current | $I_F$                | $T_C = 25\text{ °C}$              | 50       |       |
|                                  |                      | $T_C = 80\text{ °C}$              | 34       |       |
| Peak diode forward current       | $I_{FSM}$            |                                   | 180      |       |
| Gate to emitter voltage          | $V_{GE}$             |                                   | $\pm 20$ | V     |
| Power dissipation, IGBT          | $P_D$                | $T_C = 25\text{ °C}$              | 893      | W     |
|                                  |                      | $T_C = 119\text{ °C}$             | 221      |       |
| Power dissipation, diode         | $P_D$                | $T_C = 25\text{ °C}$              | 176      |       |
|                                  |                      | $T_C = 119\text{ °C}$             | 44       |       |
| Isolation voltage                | $V_{ISOL}$           | Any terminal to case, $t = 1$ min | 2500     | V     |

**Note**

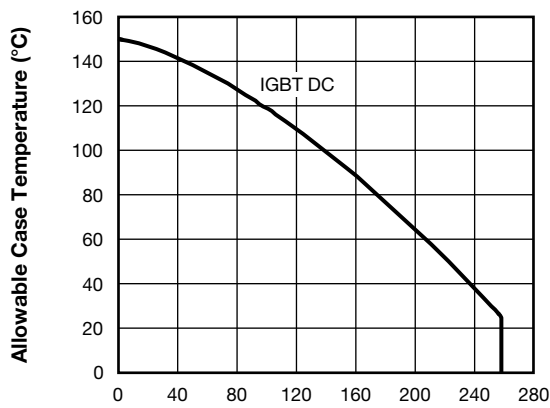
<sup>(1)</sup> Maximum continuous collector current must be limited to 100 A to do not exceed the maximum temperature of terminals

| <b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) |                                |  |      |        |           |               |
|---|--------------------------------|--|------|--------|-----------|---------------|
| PARAMETER   | SYMBOL                         | TEST CONDITIONS  | MIN. | TYP.   | MAX.      | UNITS         |
| Collector to emitter breakdown voltage  | $V_{BR(CES)}$                  | $V_{GE} = 0\text{ V}, I_C = 250\text{ }\mu\text{A}$                            | 1200 | -      | -         | V             |
| Collector to emitter voltage  | $V_{CE(on)}$                   | $V_{GE} = 15\text{ V}, I_C = 100\text{ A}$                                     | -    | 1.73   | 2.1       |               |
|   |                                | $V_{GE} = 15\text{ V}, I_C = 100\text{ A}, T_J = 125\text{ }^\circ\text{C}$    | -    | 1.98   | 2.2       |               |
| Gate threshold voltage  | $V_{GE(th)}$                   | $V_{CE} = V_{GE}, I_C = 7.5\text{ mA}$   | 4.9  | 5.9    | 7.9       |               |
| Temperature coefficient of threshold voltage  | $\Delta V_{GE(th)}/\Delta T_J$ | $V_{CE} = V_{GE}, I_C = 1\text{ mA}$ (25 °C to 125 °C)                         | -    | - 17.6 | -         | mV/°C         |
| Collector to emitter leakage current  | $I_{CES}$                      | $V_{GE} = 0\text{ V}, V_{CE} = 1200\text{ V}$                                  | -    | 0.6    | 100       | $\mu\text{A}$ |
|   |                                | $V_{GE} = 0\text{ V}, V_{CE} = 1200\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | -    | 0.6    | 10        | mA            |
| Forward voltage drop  | $V_{FM}$                       | $I_F = 40\text{ A}, V_{GE} = 0\text{ V}$                                       | -    | 2.81   | 3.3       | V             |
|   |                                | $I_F = 40\text{ A}, V_{GE} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$      | -    | 3.07   | 3.4       |               |
| Gate to emitter leakage current   | $I_{GES}$                      | $V_{GE} = \pm 20\text{ V}$   | -    | -      | $\pm 200$ | nA            |

| <b>SWITCHING CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) |              |  |            |      |      |               |
|---|--------------|--|------------|------|------|---------------|
| PARAMETER   | SYMBOL       | TEST CONDITIONS  | MIN.       | TYP. | MAX. | UNITS         |
| Turn-on switching loss  | $E_{on}$     | $I_C = 100\text{ A}, V_{CC} = 720\text{ V},$<br>$V_{GE} = 15\text{ V}, R_g = 5\text{ }\Omega,$<br>$L = 500\text{ }\mu\text{H}, T_J = 25\text{ }^\circ\text{C}$                                       | -          | 5.2  | -    | mJ            |
| Turn-off switching loss   | $E_{off}$    |  | -          | 7.1  | -    |               |
| Total switching loss  | $E_{tot}$    |  | -          | 12.3 | -    |               |
| Turn-on switching loss  | $E_{on}$     |  | -          | 6.1  | -    |               |
| Turn-off switching loss   | $E_{off}$    |  | -          | 9.8  | -    |               |
| Total switching loss  | $E_{tot}$    |  | -          | 15.9 | -    |               |
| Turn-on delay time  | $t_{d(on)}$  | $I_C = 100\text{ A}, V_{CC} = 720\text{ V},$<br>$V_{GE} = 15\text{ V}, R_g = 5\text{ }\Omega,$<br>$L = 500\text{ }\mu\text{H}, T_J = 125\text{ }^\circ\text{C}$                                      | -          | 350  | -    | ns            |
| Rise time   | $t_r$        |  | -          | 75   | -    |               |
| Turn-off delay time   | $t_{d(off)}$ |  | -          | 374  | -    |               |
| Fall time   | $t_f$        |  | -          | 493  | -    |               |
| Reverse bias safe operating area  | RBSOA        | $T_J = 150\text{ }^\circ\text{C}, I_C = 450\text{ A}, R_g = 22\text{ }\Omega,$<br>$V_{GE} = 15\text{ V to } 0\text{ V}, V_{CC} = 900\text{ V},$<br>$V_P = 1200\text{ V}, L = 500\text{ }\mu\text{H}$ | Fullsquare |      |      |               |
| Diode reverse recovery time   | $t_{rr}$     | $I_F = 50\text{ A}, di_F/dt = 200\text{ A}/\mu\text{s}, V_{rr} = 400\text{ V}$   | -          | 164  | 194  | ns            |
| Diode peak reverse current  | $I_{rr}$     |  | -          | 12   | 15   | A             |
| Diode recovery charge   | $Q_{rr}$     |  | -          | 994  | 1455 | nC            |
| Diode reverse recovery time   | $t_{rr}$     | $I_F = 50\text{ A}, di_F/dt = 200\text{ A}/\mu\text{s},$<br>$V_{rr} = 400\text{ V}, T_J = 125\text{ }^\circ\text{C}$   | -          | 230  | 273  | ns            |
| Diode peak reverse current  | $I_{rr}$     |  | -          | 16.5 | 20   | A             |
| Diode recovery charge   | $Q_{rr}$     |  | -          | 1864 | 2730 | nC            |
| Short circuit safe operating area   | SCSOA        | $T_J = 150\text{ }^\circ\text{C}, R_g = 22\text{ }\Omega,$<br>$V_{GE} = 15\text{ V to } 0\text{ V}, V_{CC} = 900\text{ V},$<br>$V_P = 1200\text{ V}$   | 10         |      |      | $\mu\text{s}$ |

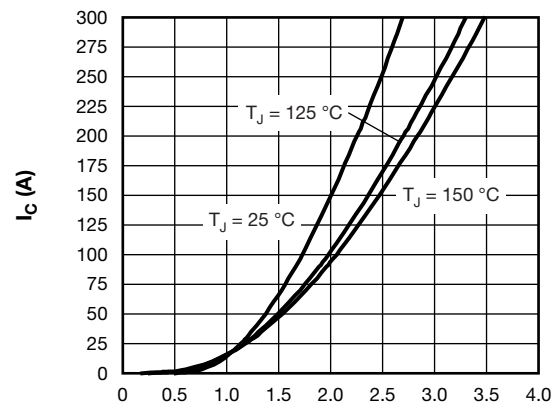


| THERMAL AND MECHANICAL SPECIFICATIONS          |                |      |      |      |                             |
|--|----------------|------|------|------|-----------------------------|
| PARAMETER                                      | SYMBOL         | MIN. | TYP. | MAX. | UNITS                       |
| Maximum junction and storage temperature range | $T_J, T_{Stg}$ | - 40 | -    | 150  | $^{\circ}\text{C}$          |
| Junction to case                               | IGBT           | -    | -    | 0.14 | $^{\circ}\text{C}/\text{W}$ |
|  | Diode          | -    | -    | 0.71 |                             |
| Case to sink per module                        | $R_{thCS}$     | -    | 0.1  | -    |                             |
| Mounting torque, 6-32 or M3 screw              |                | -    | -    | 1.3  | Nm                          |
| Weight   |                | -    | 30   | -    | g                           |



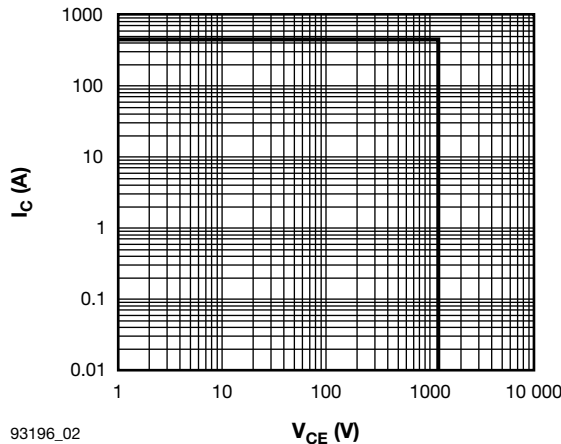
93196\_01  $I_C$  - Continuous Collector Current (A)

Fig. 1 - Maximum DC IGBT Collector Current vs. Case Temperature



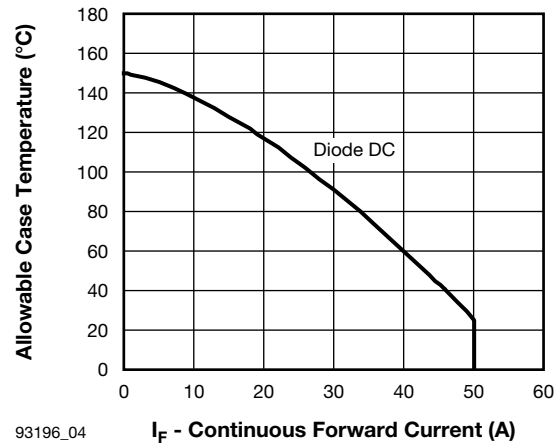
93196\_03  $V_{CE}$  (V)

Fig. 3 - Typical IGBT Collector Current Characteristics  $V_{GE} = 15\text{ V}$



93196\_02

Fig. 2 - IGBT Reverse Bias SOA  $T_J = 150\text{ }^{\circ}\text{C}, V_{GE} = 15\text{ V}$



93196\_04

$I_F$  - Continuous Forward Current (A)

Fig. 4 - Maximum DC Forward Current vs. Case Temperature

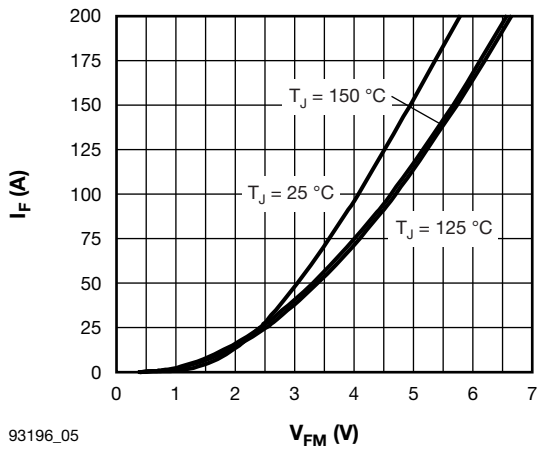


Fig. 5 - Typical Diode Forward Characteristics

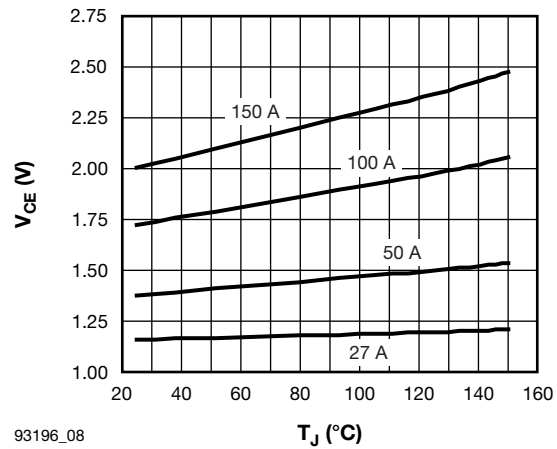


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature,  $V_{GE} = 15\text{ V}$

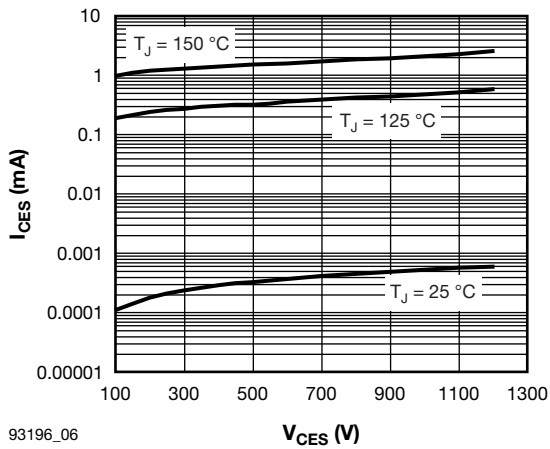


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

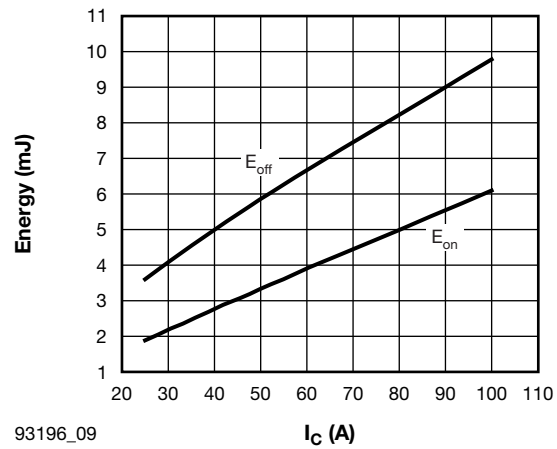


Fig. 9 - Typical IGBT Energy Loss vs.  $I_C$   
 $T_J = 125\text{ °C}$ ,  $L = 500\text{ }\mu\text{H}$ ,  $V_{CC} = 720\text{ V}$ ,  
 $R_g = 5\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$

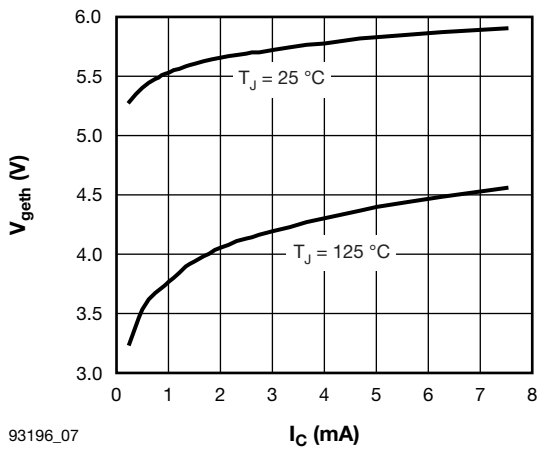


Fig. 7 - Typical IGBT Threshold Voltage

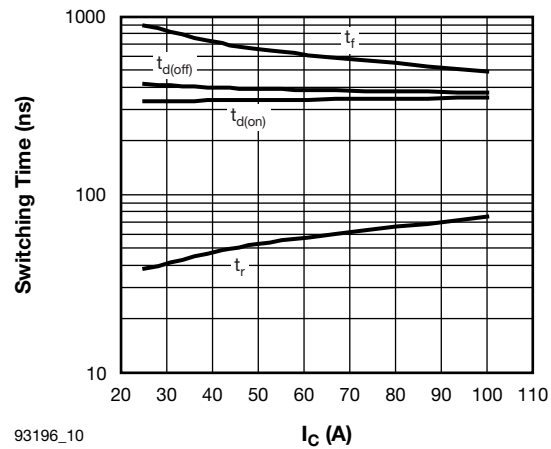


Fig. 10 - Typical IGBT Switching Time vs.  $I_C$   
 $T_J = 125\text{ °C}$ ,  $L = 500\text{ }\mu\text{H}$ ,  $V_{CC} = 720\text{ V}$ ,  
 $R_g = 5\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$

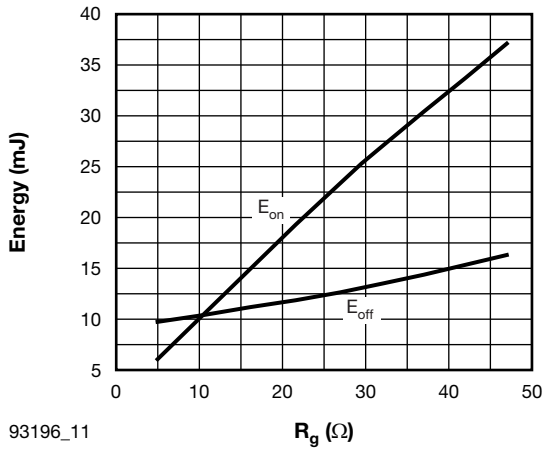


Fig. 11 - Typical IGBT Energy Loss vs.  $R_g$   
 $T_J = 125\text{ }^\circ\text{C}$ ,  $I_C = 100\text{ A}$ ,  $L = 500\text{ }\mu\text{H}$ ,  
 $V_{CC} = 720\text{ V}$ ,  $V_{GE} = 15\text{ V}$

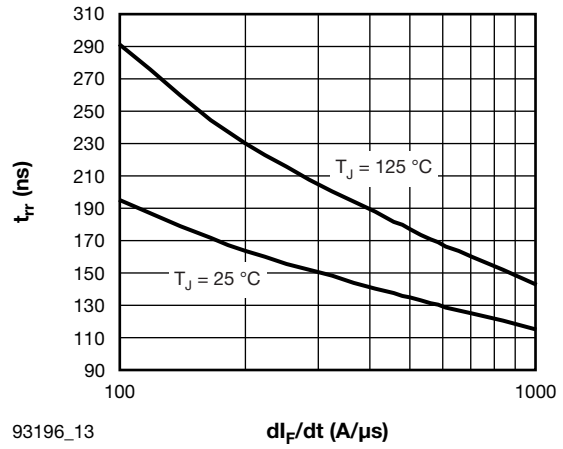


Fig. 13 - Typical  $t_{rr}$  Diode vs.  $dI_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

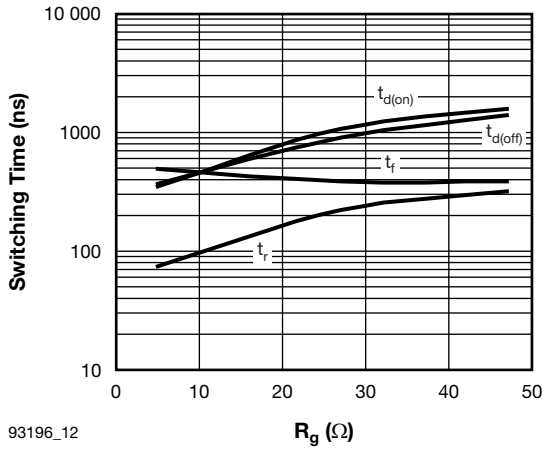


Fig. 12 - Typical IGBT Switching Time vs.  $R_g$   
 $T_J = 125\text{ }^\circ\text{C}$ ,  $L = 500\text{ }\mu\text{H}$ ,  $V_{CC} = 720\text{ V}$ ,  
 $I_C = 100\text{ A}$ ,  $V_{GE} = 15\text{ V}$

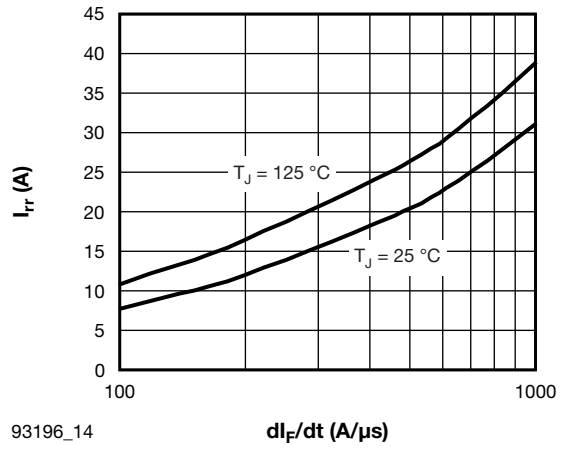


Fig. 14 - Typical  $I_{rr}$  Diode vs.  $dI_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

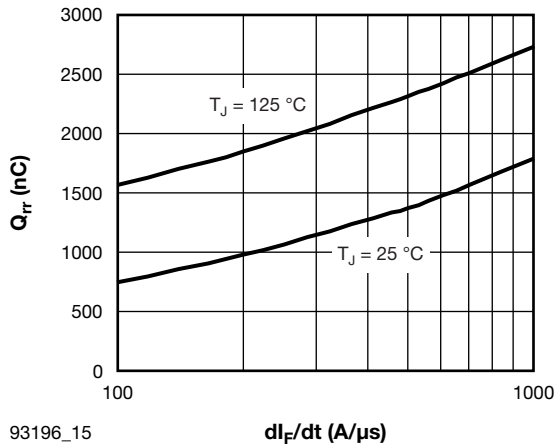


Fig. 15 - Typical  $Q_{rr}$  Diode vs.  $dI_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

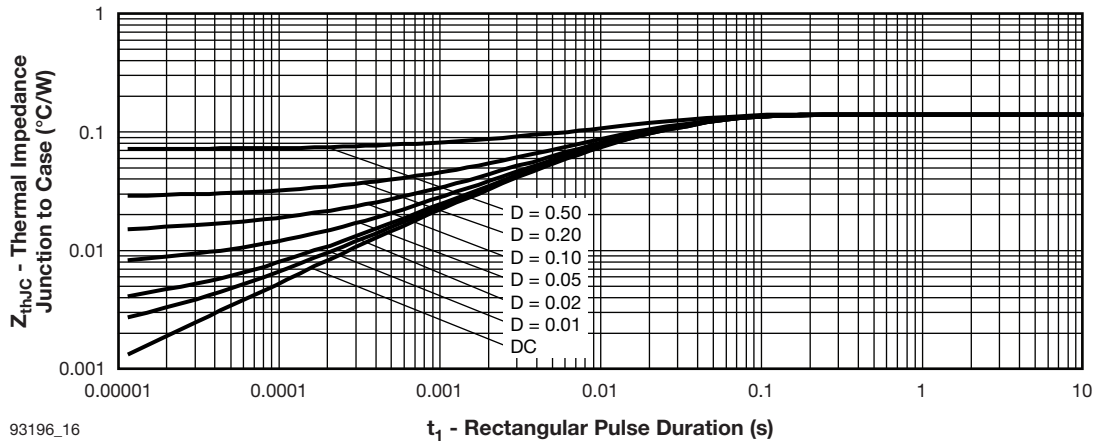


Fig. 16 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (IGBT)

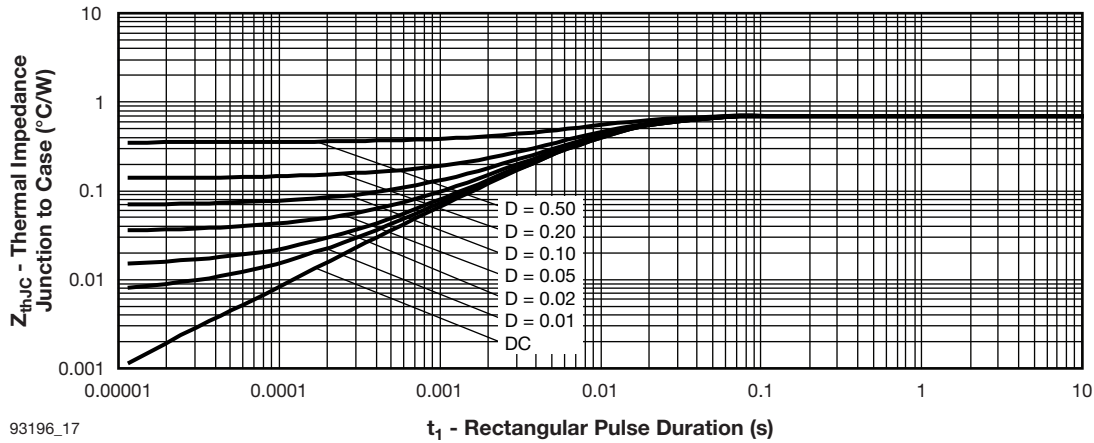
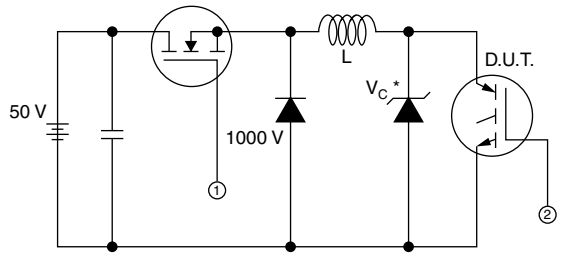


Fig. 17 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Diode)



\* Driver same type as D.U.T.;  $V_C = 80\%$  of  $V_{ce(max)}$   
 \* Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain  $I_d$

Fig. 18a - Clamped Inductive Load Test Circuit

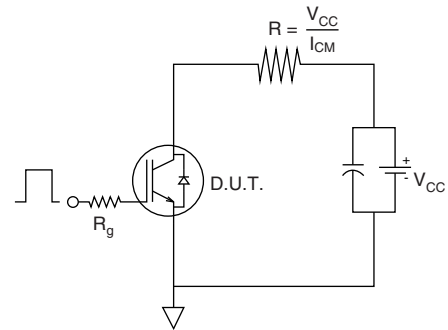


Fig. 18b - Pulsed Collector Current Test Circuit

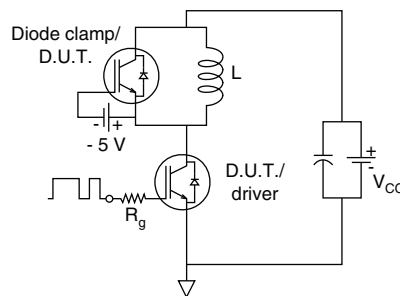


Fig. 19a - Switching Loss Test Circuit

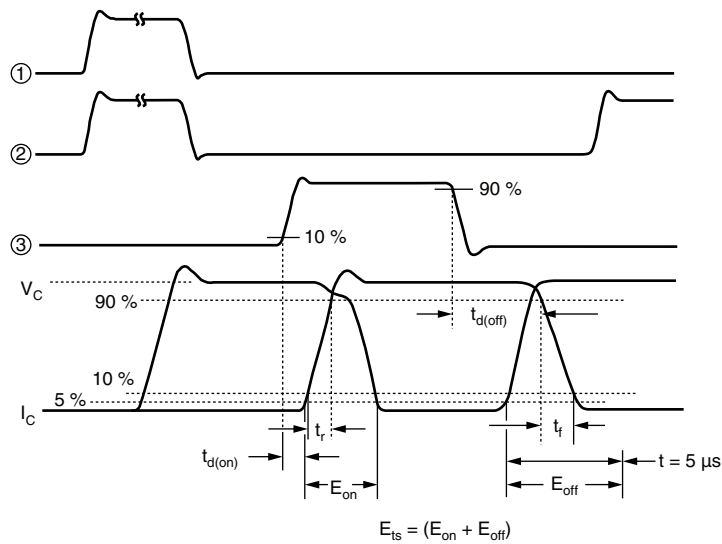


Fig. 19b - Switching Loss Waveforms Test Circuit

# GT100DA120U

Vishay Semiconductors

Insulated Gate Bipolar Transistor  
(Trench IGBT), 100 A

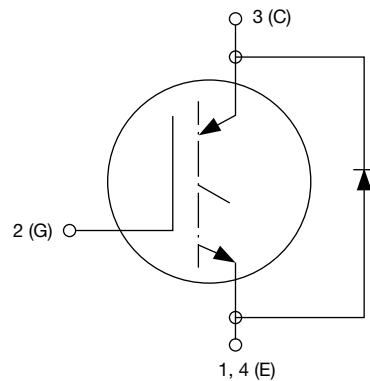


## ORDERING INFORMATION TABLE

|             |          |          |            |          |          |            |          |
|-------------|----------|----------|------------|----------|----------|------------|----------|
| Device code | <b>G</b> | <b>T</b> | <b>100</b> | <b>D</b> | <b>A</b> | <b>120</b> | <b>U</b> |
|             | ①        | ②        | ③          | ④        | ⑤        | ⑥          | ⑦        |

- 1** - Insulated Gate Bipolar Transistor (IGBT)
- 2** - T = Trench IGBT technology
- 3** - Current rating (100 = 100 A)
- 4** - Circuit configuration (D = Single switch with antiparallel diode)
- 5** - Package indicator (A = SOT-227)
- 6** - Voltage rating (120 = 1200 V)
- 7** - Speed/type (U = Ultrafast)

## CIRCUIT CONFIGURATION

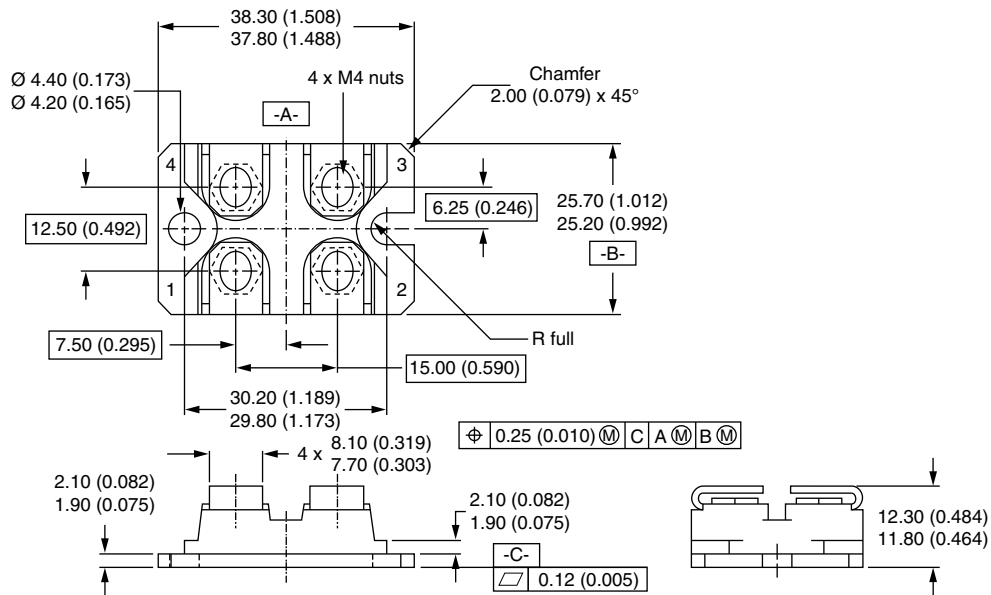


| LINKS TO RELATED DOCUMENTS |  |
|----------------------------|--|
| Dimensions                 | <a href="http://www.vishay.com/doc?95036">www.vishay.com/doc?95036</a> |
| Packaging information      | <a href="http://www.vishay.com/doc?95037">www.vishay.com/doc?95037</a> |



## SOT-227

**DIMENSIONS** in millimeters (inches)



### Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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